2SD655

Silicon NPN Epitaxial

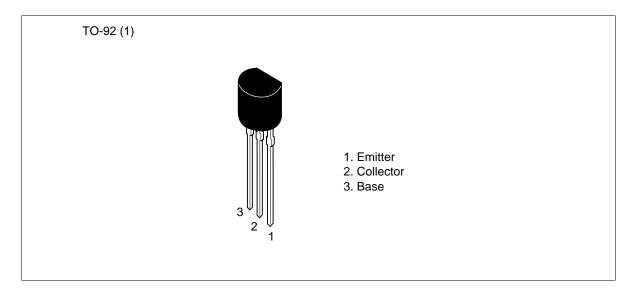
HITACHI

ADE-208-1136 (Z) 1st. Edition Mar. 2001

Application

Low frequency power amplifier, Muting

Outline





2SD655

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
Collector to emitter voltage	V _{CEO}	15	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	I _c	0.7	A
Collector peak current	i _{C(peak)}	1.0	A
Collector power dissipation	P _c	500	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

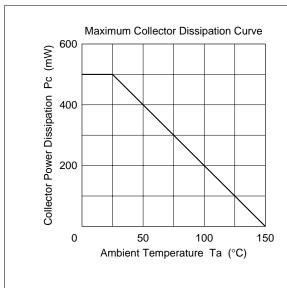
Electrical Characteristics ($Ta = 25^{\circ}C$)

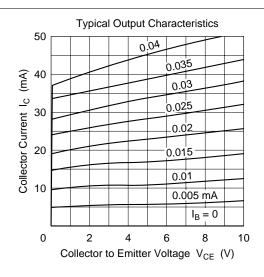
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	_	_	V	$I_{C} = 10 \ \mu\text{A}, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	15	_	_	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 10 \ \mu A, \ I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	1.0	μΑ	$V_{CB} = 20 \text{ V}, I_{E} = 0$
Base to emitter voltage	V_{BE}	_	_	1.0	V	$V_{CE} = 1 \text{ V}, I_{C} = 150 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	0.15	0.5	V	$I_{\rm C}$ = 500 mA, $I_{\rm B}$ = 50 mA* ²
DC current transfer ratio	h _{FE} *1	250	_	1200		$V_{CE} = 1 \text{ V}, I_{C} = 150 \text{ mA}^{*2}$
Gain bandwidth product	f _T	_	250	_	MHz	$V_{CE} = 1 \text{ V}, I_{C} = 150 \text{ mA}$

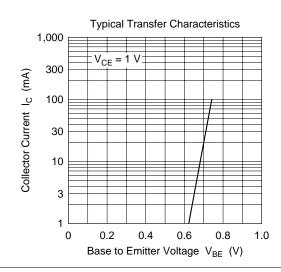
Notes: 1. The 2SD655 is grouped by h_{FE} as follows.

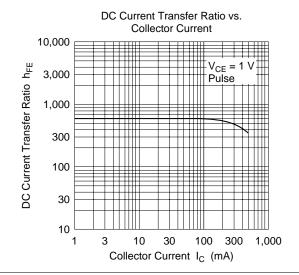
2. Pulse test

D	E	F
250 to 500	400 to 800	600 to 1200

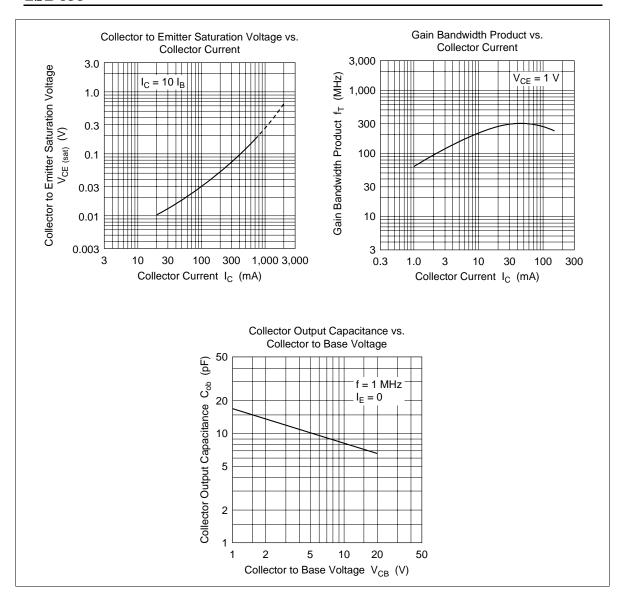




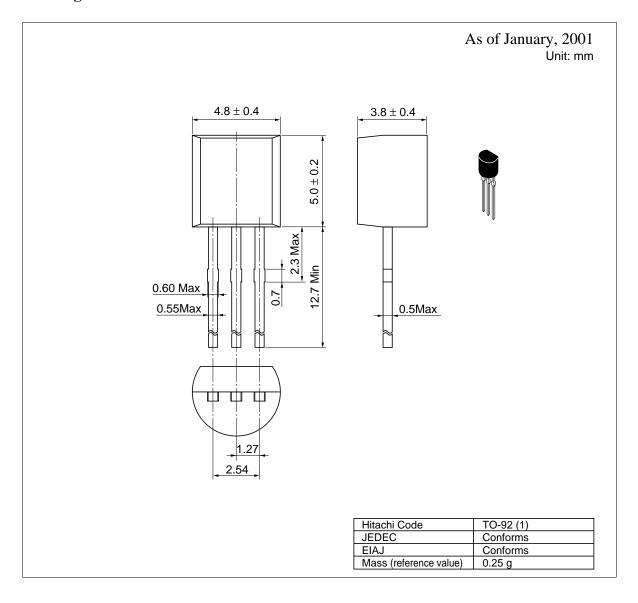




2SD655



Package Dimensions



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